



LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

Product Summary

V _{BR Min}	I _{PP Max}	C _{IN Typ}
8.5V	4A	8.5pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Provides ESD Protection per IEC 61000-4-2 Standard:
 Air ±30kV, Contact ±25kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: X3-DFN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin over Copper Leadframe, per MIL-STD-202, Method 208
- Weight: 0.0002 grams (Approximate)

X3-DFN0603-2



Top View



Bottom View



Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D8V0L1B2LP3-7	Standard	00	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

00

OO = Product Type Marking Code



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	66	W	8/20µs, per Figure 3
Peak Pulse Current	I _{PP}	4	Α	8/20µs, per Figure 3
ESD Protection - Contact Discharge	V _{ESD_CONTACT}	±25	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_AIR}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

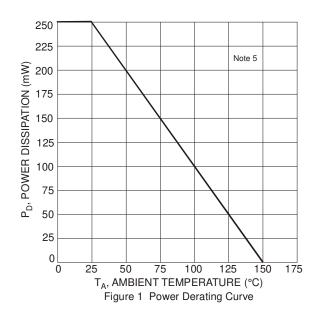
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

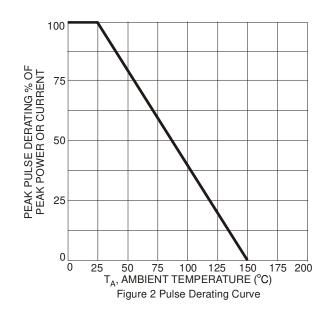
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	_	8	V	_
Channel Leakage Current (Note 6)	I _{RM}	_	_	50	nA	V _{RWM} = 8V
Breakdown Voltage	V _{BR}	8.5	_	12	V	I _R = 1mA
Clamping Voltage, Positive Transients		_	_	12.5	V	$I_{PP} = 1A$, $t_P = 8/20 \mu s$
	V _{CL}	_	_	16.5		$I_{PP} = 4A, t_P = 8/20 \mu s$
FOR Observing Wells are (Nests 7)	V	_	13.0	_	V	I _{PP} = 4A, t _P = 10/100ns
ESD Clamping Voltage (Note 7)	V _C	_	18.8	_		I _{PP} = 16A, t _P = 10/100ns
Differential Resistance	R _{DYN}	_	0.4	_	Ω	I _{TLP} = 10A to 20A, t _P = 100ns, I/O to GND
Channel Input Capacitance	C _{IN}	_	8.5	_	pF	V _R = 0V, f = 1MHz

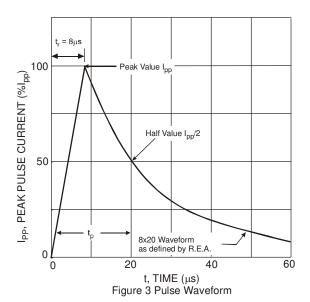
Notes:

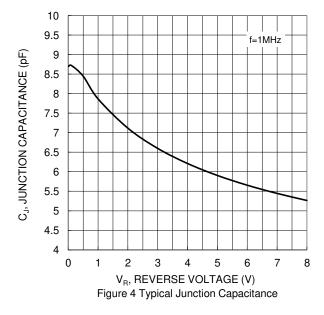
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Transmission Line Pulse Test (TLP) settings: tp=100ns, tr=10ns, I_{TLP} and V_{TLP} averaging window is from 70ns to 90ns.

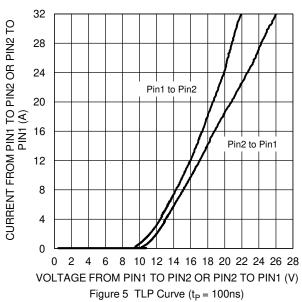






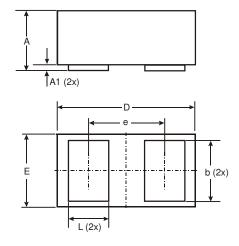






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

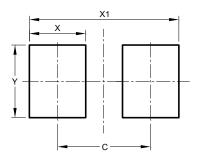


	X3-DFN0603-2					
Dim	Min	Max	Тур			
Α	0.27	0.35	0.30			
A 1	0.00	0.03	0.02			
b	0.19	0.29	0.24			
D	0.595	0.645	0.62			
Е	0.295	0.345	0.32			
е	-	-	0.355			
L	0.14	0.24	0.19			
All	All Dimensions in mm					



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.380
Х	0.230
X1	0.610
Υ	0.300

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